

Image

2827

TS-9-149B

Application No. 09/755,282

November 17, 2003

TO: Commissioner for Patents  
P.O. Box 1435  
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572  
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SUBJECT: Serial #: 09/755,282  
File Date: 01/08/01  
Inventor: CHEN, SHENG-HSIUNG  
Examiner: MITCHELL, JAMES M.  
Art Unit: 2827  
Title: METHOD OF IMPROVING COPPER PAD ADHESION

RESPONSE TO OFFICE ACTION

This is in response to the office action dated September 08, 2003. Please amend the above identified Divisional Application for patent as follows.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1435, Alexandria, VA 22313-1450 on December 8, 2003.

Signature  Date: 12/8/03

Stephen B. Ackerman, Reg. No. 37,761